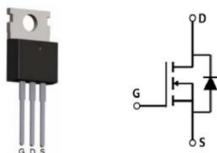




### N-Channel Enhancement Mode Field Effect Transistor



TO-220

### **Product Summary**

V<sub>DS</sub> 60V
I<sub>D</sub> 150A
R<sub>DS(ON)</sub>( at V<sub>GS</sub>=10V) <5.5mohm</li>

• 100% UIS Tested

100% ∇V<sub>DS</sub> Tested

### **General Description**

- Trench Power MV MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low R<sub>DS(ON)</sub>

### **Applications**

- DC-DC Converters
- Power management functions
- Industrial and Motor Drive applications

### ■ **Absolute Maximum Ratings** (T<sub>A</sub>=25 °C unless otherwise noted)

| Parameter                         |                       | Symbol                           | Limit    | Unit          |  |
|-----------------------------------|-----------------------|----------------------------------|----------|---------------|--|
| Drain-source Voltage              |                       | V <sub>DS</sub>                  | 60       | V             |  |
| Gate-source Voltage               |                       | V <sub>GS</sub> ±20              |          |               |  |
| Drain Current                     | T <sub>C</sub> =25°C  |                                  | 150      | А             |  |
|                                   | T <sub>C</sub> =100°℃ | l <sub>D</sub>                   | 105      |               |  |
| Pulsed Drain Current <sup>A</sup> |                       | I <sub>DM</sub>                  | 500      | А             |  |
| Total Power Dissipation           | T <sub>C</sub> =25°C  | P <sub>D</sub>                   | 225      | W             |  |
|                                   | T <sub>C</sub> =100°C | PD                               | 112      | W             |  |
| Single Pulse Avalanche Energy     |                       | E <sub>AS</sub>                  | 550      | mJ            |  |
| Thermal Resistance Junction-to    | -Case <sup>B</sup>    | R <sub>eJC</sub>                 | uc 0.67  |               |  |
| Junction and Storage Temperat     | ure Range             | T <sub>J</sub> ,T <sub>STG</sub> | -55∼+175 | ${\mathbb C}$ |  |

■ Ordering Information (Example)

| PREFERED P/N | PACKING<br>CODE | Marking     | MINIMUM<br>PACKAGE(pcs) | INNER BOX<br>QUANTITY(pcs) | OUTER CARTON<br>QUANTITY(pcs) | DELIVERY MODE |
|--------------|-----------------|-------------|-------------------------|----------------------------|-------------------------------|---------------|
| YJP150N06AQ  | B1              | YJP150N06AQ | 50                      | 1                          | 5000                          | 13" reel      |



■ Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)

| Parameter                             |                     | Symbol              | Conditions  | Min |      | Max  | Units |
|---------------------------------------|---------------------|---------------------|---|-----|------|------|-------|
| Static Parameter                      |                     |                     |   | •   |      |      |       |
| Drain-Source Breakdown Voltage        |                     | BV <sub>DSS</sub>   | V <sub>GS</sub> = 0V, I <sub>D</sub> =250μA                   | 60  |      |      | ٧     |
| Zero Gate Voltage Drain<br>Current    | T <sub>J</sub> =25℃ | 1                   | V <sub>DS</sub> =60V,V <sub>GS</sub> =0V                      |     |      | 1    | μΑ    |
|                                       | T <sub>J</sub> =55℃ | I <sub>DSS</sub>    |   |     |      | 5    | uA    |
| Gate-Body Leakage Current             |                     | I <sub>GSS</sub>    | $V_{GS}$ = $\pm 20V$ , $V_{DS}$ = $0V$                        |     |      | ±100 | nA    |
| Gate Threshold Voltage                |                     | $V_{GS(th)}$        | $V_{DS}$ = $V_{GS}$ , $I_D$ =250 $\mu$ A                      | 2.0 | 3.0  | 4.0  | V     |
| Static Drain-Source On-Resista        | nce                 | R <sub>DS(ON)</sub> | V <sub>GS</sub> = 10V, I <sub>D</sub> =75A                    |     | 4.6  | 5.5  | mΩ    |
| Diode Forward Voltage                 |                     | V <sub>SD</sub>     | I <sub>S</sub> =40A,V <sub>GS</sub> =0V                       |     | 0.8  | 1.2  | V     |
| Maximum Body-Diode Continuous Current |                     | Is                  |   |     |      | 150  | А     |
| Dynamic Parameters                    |                     |                     |   |     |      |      |       |
| Input Capacitance                     |                     | C <sub>iss</sub>    |   |     | 4200 |      | pF    |
| Output Capacitance                    |                     | C <sub>oss</sub>    | V <sub>DS</sub> =30V,V <sub>GS</sub> =0V,f=1MHZ               |     | 475  |      |       |
| Reverse Transfer Capacitance          |                     | C <sub>rss</sub>    |   |     | 207  |      |       |
| Switching Parameters                  |                     |                     |   |     |      |      |       |
| Total Gate Charge                     |                     | $Q_g$               |   |     | 69   |      | - nC  |
| Gate-Source Charge                    |                     | $Q_{gs}$            | V <sub>GS</sub> =10V,V <sub>DS</sub> =30V,I <sub>D</sub> =50A |     | 33   |      |       |
| Gate-Drain Charge                     |                     | $Q_{gd}$            |   |     | 15   |      |       |
| Reverse Recovery Charge               |                     | Q <sub>rr</sub>     | 1_404_di/dt_4004/:  |     | 98   |      |       |
| Reverse Recovery Time                 |                     | t <sub>rr</sub>     | I <sub>F</sub> =40A, di/dt=100A/us                            |     | 53   |      |       |
| Turn-on Delay Time                    |                     | t <sub>D(on)</sub>  |   |     | 18   |      | ns    |
| Turn-on Rise Time                     |                     | t <sub>r</sub>      | $V_{GS}=10V, V_{DD}=30V, I_{D}=2A, R_{L}=15\Omega$            |     | 35   |      |       |
| Turn-off Delay Time                   |                     | $t_{D(off)}$        | $R_{\text{GEN}}=3\Omega$                                      |     | 44   |      |       |
| Turn-off fall Time                    |                     | t <sub>f</sub>      |   |     | 23   |      |       |

A. Pulse Test: Pulse Width≤300us, Duty cycle ≤2%.

B.  $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta JC}$  is guaranteed by design, while  $R_{\theta JA}$  is determined by the board design. The maximum rating presented here is based on mounting on a 1 in 2 pad of 2oz copper.



### ■ Typical Performance Characteristics

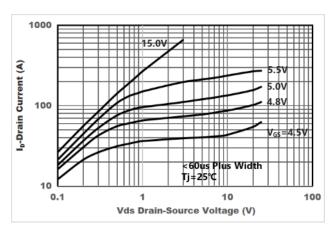


Figure 1. Output Characteristics

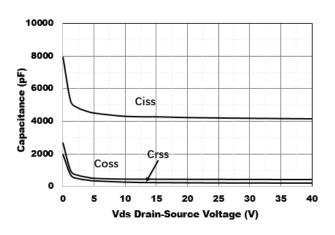


Figure 3. Capacitance Characteristics

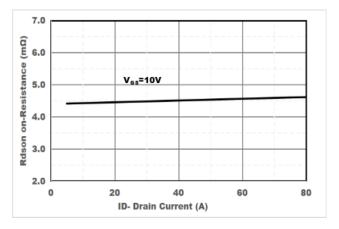


Figure 5. Drain-Source on Resistance

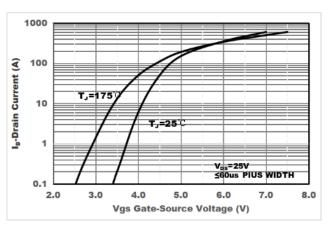


Figure 2. Transfer Characteristics

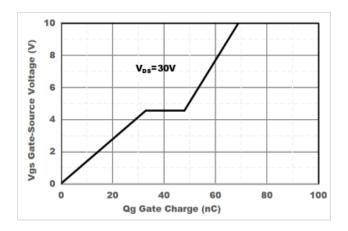


Figure 4. Gate Charge

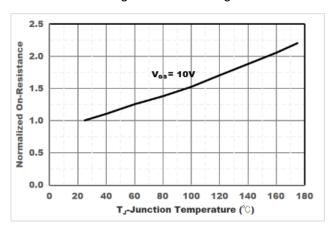


Figure 6. Drain-Source on Resistance



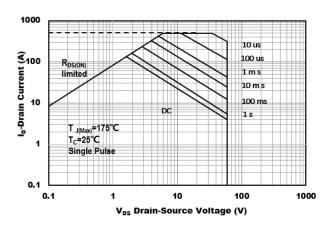


Figure 7. Safe Operation Area

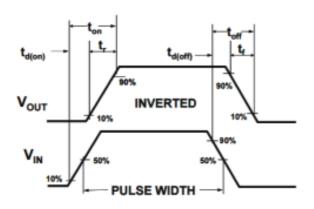
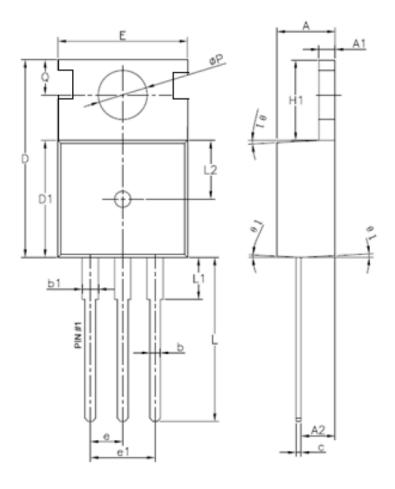


Figure8. Switching wave



# ■ TO-220 Package information



| Symbol | Min  | Normal | Max  | Symbol | Min  | Normal | Max  |
|--------|------|--------|------|--------|------|--------|------|
| А      | 4.4  | 4.5    | 4.6  | е      |      | 2.54   |      |
| A1     | 1.27 | 1.3    | 1.33 | e1     |      | 5.08   |      |
| A2     | 2.3  | 2.4    | 2.5  | H1     | 6.3  | 6.5    | 6.7  |
| b      | 0.7  | /      | 0.9  | L      | 13.0 | 13.38  | 13.5 |
| b1     | 1.25 | /      | 1.42 | L1     | /    | /      | 3.5  |
| С      | 0.45 | 0.5    | 0.6  | L2     |      | 4.6    |      |
| D      | 15.3 | 15.7   | 16.1 | ФР     | 3.55 | 3.6    | 3.65 |
| D1     | 9.1  | 9.2    | 9.3  | Q      | 2.73 | /      | 2.87 |
| Е      | 9.7  | 9.9    | 10.2 | θ1(°)  | 1    | 3      | 5    |



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